

Title (en)
IMPROVED BLISTER-MAKING MACHINE, CONNECTED METHOD FOR PACKING IN BLISTERS, AND BLISTER PACK THUS OBTAINED

Title (de)
VERBESSERTE MASCHINE ZUR HERSTELLUNG VON BLISTERPACKUNGEN, ENTSPRECHENDES VERFAHREN ZUM VERPACKEN IN BLISTERPACKUNGEN UND AUF DIESE WEISE HERGESTELLTE BLISTERPACKUNG

Title (fr)
MACHINE AMÉLIORÉE DE FABRICATION DE BLISTERS ET PROCÉDÉ CONNEXE D'EMBALLAGE SOUS BLISTERS AINSI OBTENU

Publication
EP 2771244 A1 20140903 (EN)

Application
EP 12799271 A 20121024

Priority
• IT MI20111944 A 20111026
• IB 2012002142 W 20121024

Abstract (en)
[origin: WO2013061137A1] Improved blister-making machine which, starting from a moldable strip (11), from a covering strip (14) and from noxious material (33) delivered and positioned by a distributor device (16) inside the blisters (30) made in the moldable strip (11), all being subsequently sealed by a sealing device (18), produces blister packs of the desired shape and sizes, wherein upstream of the sealing device (18) there is an insulated chamber (15) containing a pre-sealing device (17) continuously achieving continuous sealed bands (19) in proximity with at least two lateral edges (119) of the blister strip (13).

IPC 8 full level
B65B 9/04 (2006.01); **B65B 31/02** (2006.01); **B65B 55/24** (2006.01)

CPC (source: EP US)
B65B 1/02 (2013.01 - US); **B65B 9/04** (2013.01 - EP US); **B65B 29/00** (2013.01 - US); **B65B 31/02** (2013.01 - US); **B65B 31/021** (2013.01 - EP US); **B65B 47/00** (2013.01 - US); **B65B 55/24** (2013.01 - EP US)

Citation (search report)
See references of WO 2013061137A1

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)
WO 2013061137 A1 20130502; CN 104024110 A 20140903; EP 2771244 A1 20140903; EP 2771244 B1 20150916; ES 2549658 T3 20151030; IN 1046KON2014 A 20151009; IT MI20111944 A1 20130427; JP 2015500774 A 20150108; JP 6157487 B2 20170705; US 2014298756 A1 20141009

DOCDB simple family (application)
IB 2012002142 W 20121024; CN 201280064459 A 20121024; EP 12799271 A 20121024; ES 12799271 T 20121024; IN 1046KON2014 A 20140517; IT MI20111944 A 20111026; JP 2014537740 A 20121024; US 201214354678 A 20121024